

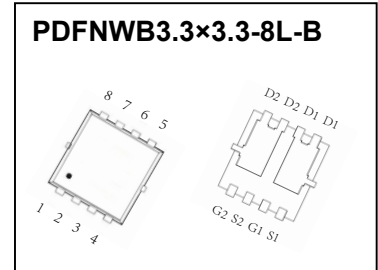


JIANGSU CHANGJING ELECTRONICS TECHNOLOGY CO., LTD

PDFNWB3.3×3.3-8L-B Plastic-Encapsulate MOSFETS

CJBD3020 N-Channel Power MOSFET

$V_{(BR)DSS}$	$R_{DS(on)}$ TYP	I_D
30V	9.5mΩ@10V	20A
	14.5mΩ@4.5V	



DESCRIPTION

The CJBD3020 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications

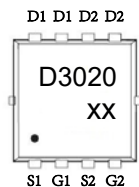
FEATURES

- Battery switch
- Load switch
- High density cell design for ultra low $R_{DS(ON)}$
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

APPLICATIONS

- SMPS and general purpose applications
- Hard switched and high frequency circuits
- Uninterruptible Power Supply

MARKING

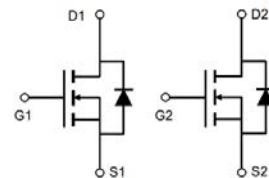


D3020=Part No.

Solid dot=Pin1 indicator

XX=Date Code

EQUIVALENT CIRCUIT



MAXIMUM RATINGS ($T_J=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	±20	V
Continuous Drain Current	I_D ①	20	A
Pulsed Drain Current	I_{DM} ②	100	A
Single Pulsed Avalanche Energy	E_{AS} ③	70	mJ
Power Dissipation	P_D ①	25	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$ ⑤	83.3	$^{\circ}\text{C/W}$
Thermal Resistance from Junction to Case	$R_{\theta JC}$ ①	5.0	$^{\circ}\text{C/W}$
Junction and Storage Temperature Range	T_J, T_{stg}	-55 ~+150	$^{\circ}\text{C}$

MOSFET ELECTRICAL CHARACTERISTICS

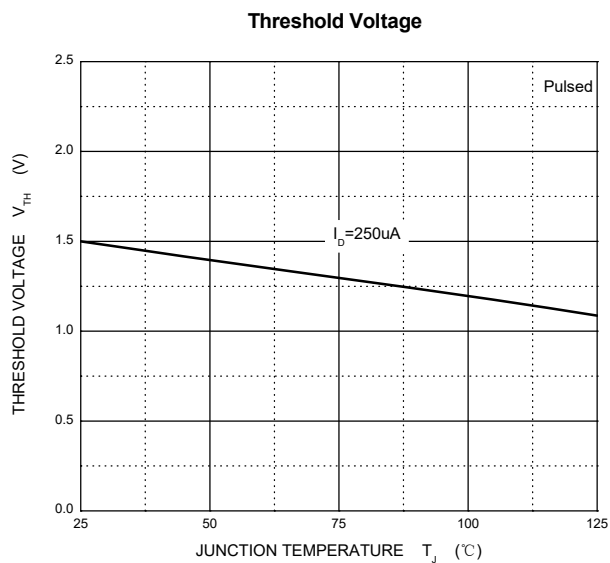
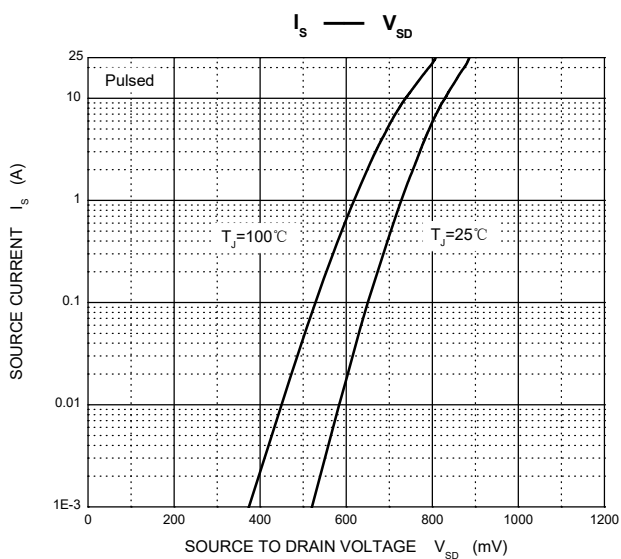
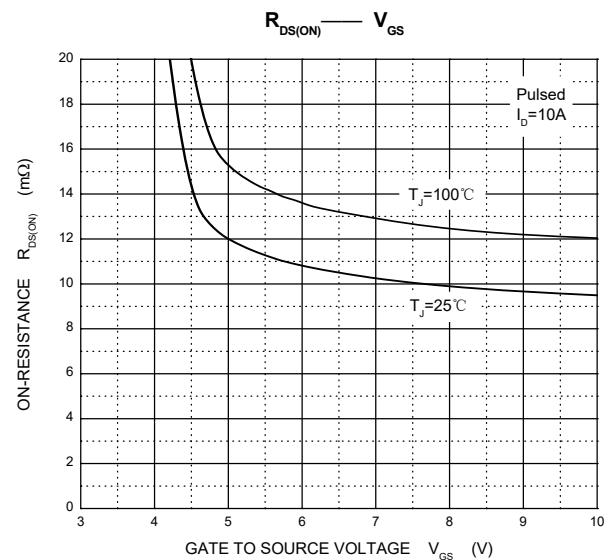
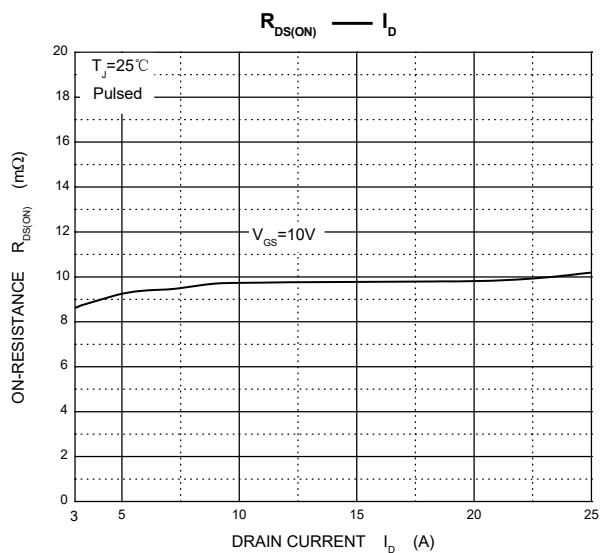
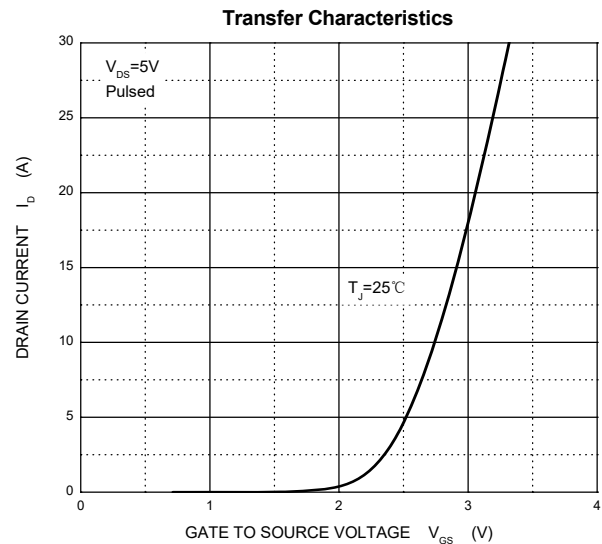
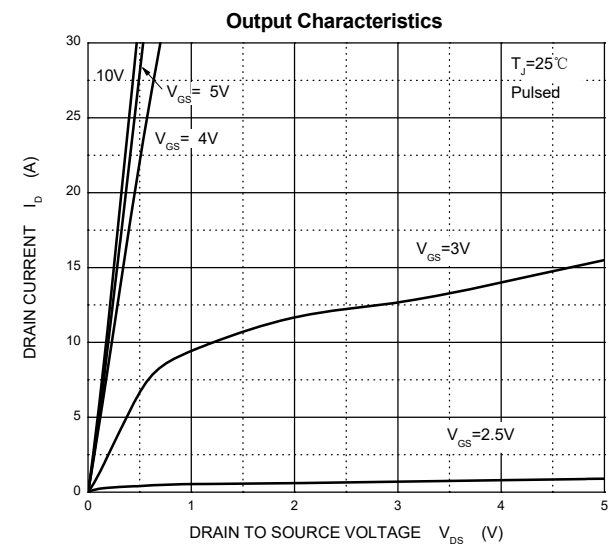
T_J=25 °C unless otherwise specified

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Off characteristics						
Drain-source breakdown voltage	V _{(BR) DSS}	V _{GS} = 0V, I _D =250μA	30			V
Zero gate voltage drain current	I _{DSS}	V _{DS} =30V, V _{GS} =0V			1	μA
Gate-body leakage current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA
On characteristics ^④						
Gate-threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	1.0	1.8	3.0	V
Static drain-source on-sate resistance	R _{DS(on)}	V _{GS} =10V, I _D =10A		9.5	15	mΩ
		V _{GS} =4.5V, I _D =10A		14.5	20	mΩ
Forward transconductance	g _{FS}	V _{DS} =5V, I _D =20A	15			S
Dynamic characteristics						
Input capacitance	C _{iss}	V _{DS} =15V, V _{GS} =0V, f =1MHz		823		pF
Output capacitance	C _{oss}			138		
Reverse transfer capacitance	C _{rss}			100		
Switching characteristics						
Total gate charge	Q _g	V _{DS} =15V, V _{GS} =10V, I _D =9A		14		nC
Gate-source charge	Q _{gs}			3.5		
Gate-drain charge	Q _{gd}			4.5		
Turn-on delay time	t _{d(on)}	V _{DD} =15V, V _{GS} =10V, R _L =1.8Ω, R _G =1.8Ω			10	ns
Turn-on rise time	t _r				8	
Turn-off delay time	t _{d(off)}				30	
Turn-off fall time	t _f				5	
Drain-Source Diode Characteristics						
Drain-source diode forward voltage	V _{SD} ^④	V _{GS} =0V, I _S =10A			1.2	V
Continuous drain-source diode forward current	I _S ^①				20	A
Pulsed drain-source diode forward current	I _{SM} ^②				100	A
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F = 10A		22	35	ns
Reverse Recovery Charge	Q _{rr}	di/dt = 100A/μs(Note1)		12	20	nC

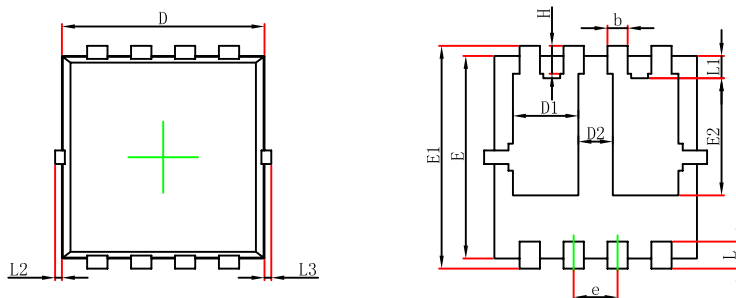
Notes:

- 1.T_C=25°C Limited only by maximum temperature allowed.
- 2.P_W≤10μs, Duty cycle≤1%.
- 3.EAS condition: V_{DD}=15V, L=0.14mH, R_g=25Ω Starting T_J = 25°C.
- 4.Pulse Test : Pulse Width≤300μs, duty cycle ≤2%.
- 5.Device mounted on 1 in² FR-4 board, single-side active, in a still air environment with T_A=25°C.

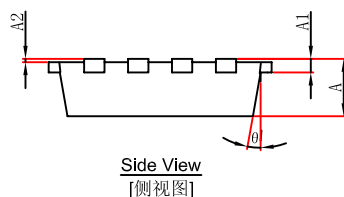
Typical Characteristics



PDFNWB3.3×3.3-8L-B Package Outline Dimensions



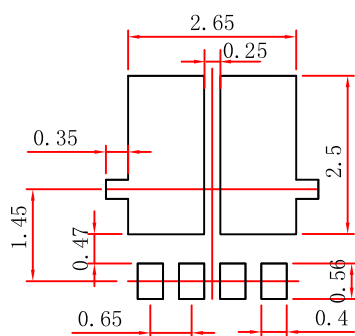
Top View
[顶视图]



Side View
[侧视图]

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.650	0.850	0.026	0.033
A1	0.152 REF.		0.006 REF.	
A2	0~0.05		0~0.002	
D	2.900	3.100	0.114	0.122
D1	0.935	1.135	0.037	0.045
D2	0.280	0.480	0.011	0.019
E	2.900	3.100	0.114	0.122
E1	3.150	3.450	0.124	0.136
E2	1.535	1.935	0.060	0.076
b	0.200	0.400	0.008	0.016
e	0.550	0.750	0.022	0.030
L	0.300	0.500	0.012	0.020
L1	0.180	0.480	0.007	0.019
L2	0~0.100		0~0.004	
L3	0~0.100		0~0.004	
H	0.315	0.515	0.012	0.020
θ	9°	13°	9°	13°

PDFNWB3.3×3.3-8L-B Suggested Pad Layout



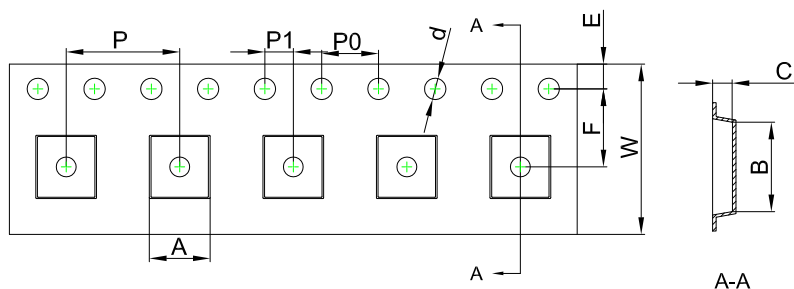
Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.

NOTICE

JSCJ reserves the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. JSCJ does not assume any liability arising out of the application or use of any product described herein.

PDFNWB3.3×3.3-8L-B Embossed Carrier Tape

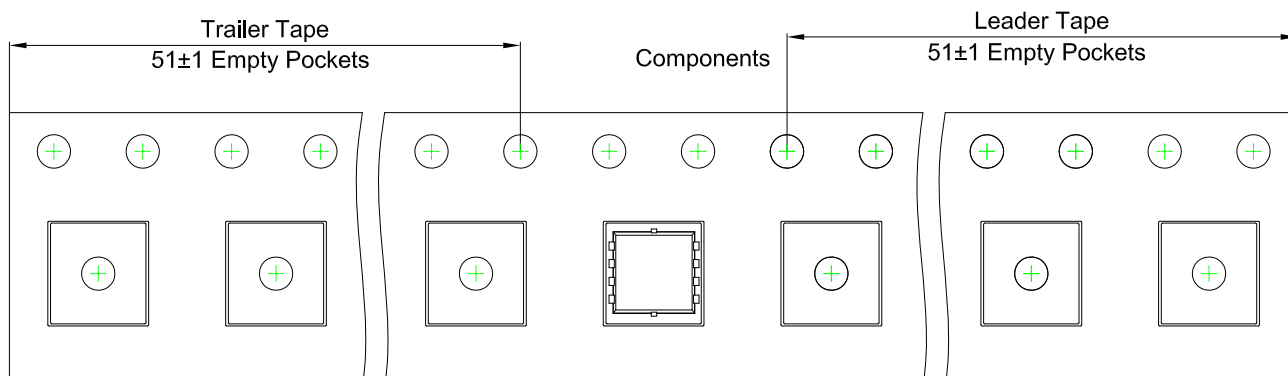


Packaging Description:

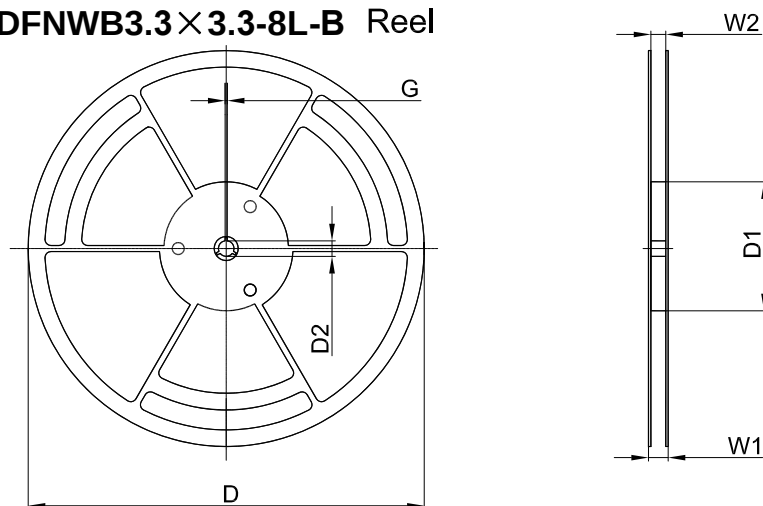
PDFNWB3.3×3.3-8L-B parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 5,000 units per 13" or 33.0 cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).

Dimensions are in millimeter										
Pkg type	A	B	C	d	E	F	P0	P	P1	W
PDFNWB3.3×3.3-8L-B	3.55	3.55	1.10	Ø1.50	1.75	5.50	4.00	8.00	2.00	12.00

PDFNWB3.3×3.3-8L-B Tape Leader and Trailer



PDFNWB3.3×3.3-8L-B Reel



Dimensions are in millimeter						
Reel Option	D	D1	D2	G	W1	W2
13"Dia	Ø330.00	100.00	13.00	1.90	17.60	12.40

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)
5,000 pcs	13 inch	5,000 pcs	340×336×29	50,000 pcs	353×346×365